



Product Selector Interpolation ICs • Silicon for Motion®

	iC-NV iC-NVH	iC-TW2	iC-TW28 NEW	iC-MG iC-MQ	iC-MQF	iC-PI NEW	iC-NG	iC-NQC	iC-NQI	iC-MN	iC-MNF NEW	iC-MR3 NEW	iC-TW8	
	<i>(H: half cycle Z)</i>													
ADC	6 bit	8 bit	10 bit	8 bit / 9 bit	12 bit	12 bit	8 bit	13 bit	13 bit	3x 13 bit S&H	3x 14 bit S&H	13 bit S&H	16 bit	
Conversion Rate	30 ns	30 Msps @ 5V	3.1 Msps	5 Msps	20 Msps	40 Msps	800 ksps	1.7...8 Msps	1.7...8 Msps	140 ksps (1 Ch.)	210 (280) ksps (1 Ch.)	250 ksps	250 ksps	
Principle	flash	vector tracking	ATAN calc.	vector tracking	vector tracking	vector tracking	vector tracking	vector tracking	vector tracking	SAR	SAR	SAR	ATAN calc.	
Latency/Lag	< 250 ns	0.6 to 2.4 µs	1.5 µs / < 1 µs with lag recovery	200 ns	< 250 ns	< 250 ns	1.2 µs	< 250 ns	< 250 ns	5 µs	3 µs (2 µs)	2 µs	24 µs / < 4 µs w. lag recovery	
Accuracy (deg/el.period)	5.6°	4.2°	0.7°	0.7°	0.13°	0.13°	1.4°	0.35°	0.35°	0.1°	0.1°	0.1°	0.1°	
Max. Angle Resolution	64	256	1024	200 / 400	4000	4000 / 4096	256	8192	8192	8192 (1 Ch.)	16384 (1 Ch.)	8192	fractional, up to 65536	
Signal Conditioning			by push-button				• by opamp						by push-button	
Offset	-	•	• automatic	•	•	•	•	•	•	• 3x	• 3x	•	• automatic	
Amplitude	-	•	• automatic	•	•	•	•	•	•	• 3x	• 3x	•	• automatic	
Phase	-	-	• automatic	•	•	•	•	•	•	• 3x	• 3x	•	• automatic	
Linearization							• by conversion						• LUT	
Stabilization			• LED/MR bridge control	• LED/MR bridge control	• LED/MR bridge control	• LED/MR bridge control				• LED/MR bridge control	• LED/MR bridge control	• LED/MR bridge control		
Incr. Data (A,B,Z)	• +/- 4 mA	• +/- 6 mA diff. • 1 CPR	• RS422 • 1 to 32 CPR • 10+14 bit	• RS422	• RS422	• RS422	• +/- 4 mA	• +/- 4 mA	• +/- 4 mA				• +/- 4 mA	
Comm. Data (U,V,W)														
Absolute Data							• 8 bit	• up to 13+24 bit test mode	• up to 13+24 bit test mode	• up to 25+24 bit • 1 Vpp (100 Ω)	• up to 26+24 bit • 1 Vpp (100 Ω)	• up to 26+24 bit • 1 Vpp (100 Ω)	• 32 bit	
Sin/Cos Output				test mode	test mode	test mode		BiSS C, SSI	BiSS (B)	BiSS C, SSI	BiSS C, SSI, SPI	BiSS C, SSI, SPI	3/4-wire SPI	
Serial I/O		2-wire SPI	4-wire SPI, EncoderLink®				• 8 bit							
Parallel I/O				• multi-master	• multi-master	• multi-master	•						• 8 bit	
I2C Master													•	
On-Chip EEPROM		•	•											
Multiturn Interface			via MCU			• index inp.				• BiSS C, SSI	• BiSS C, SSI	• BiSS C, SSI		
Period Counting			• 14 bit with preset by MCU			• 15 bit	• 24 bit	• 24 bit	• 24 bit	• 24 bit with preset	• 24 bit with preset	• 24 bit with preset	• 16 bit	
Setup	3 pins	On-chip EEPROM, SPI	by pins, SPI, EEPROM, EncoderLink®	ext. EEPROM	ext. EEPROM	ext. EEPROM	ext. EEPROM, µC	ext. EEPROM	ext. EEPROM	ext. EEPROM	ext. EEPROM	ext. EEPROM, µC	by 4 pins, µC, ext. EEPROM	
Supply	5 V (10 mA)	3.3 to 5 V (8 mA)	3.3 V (25 mA)	5 V (12 mA)	5 V (18 mA)	5 V (28 mA)	5 V (25 mA max.)	5 V (35 mA max.)	5 V (35 mA max.)	5 V (45 mA)	5 V (60 mA)	5 V, 2.5 to 5V (34 mA)	3.1 to 5.5 V (12 to 25 mA)	
Specials			touch probe hold register							Nonius calc.	Nonius calc., 2 GPIO pins	safety diagnostics, temperature value (12 bit)	velocity value (14 bit)	
Package	TSSOP20	QFN24 4x4	QFN32 5x5	TSSOP20	TSSOP20	TSSOP20	SO28 SSOP28 5.3	TSSOP20	TSSOP20	QFN48 7x7	QFN48 7x7	QFN48 7x7	QFN48 7x7	

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